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PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2660707

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
HYUNSEUNG SEO	12/13/2013	
YOUNGHO KIM	12/13/2013	
JIHOON SHIN	12/13/2013	

RECEIVING PARTY DATA

Name:	LG Electronics Inc.			
Street Address:	20 Yeouido-dong Yeongdeungpo-gu			
City:	Seoul			
State/Country:	REPUBLIC OF KOREA			
Postal Code:	150-721			

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29477735

CORRESPONDENCE DATA

 Fax Number:
 (202)739-3001

 Phone:
 2027393000

Email: patents@morganlewis.com, kcasavecchia@morganlewis.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: ROBERT J. GAYBRICK
Address Line 1: 1111 PENNSYLVANIA AVE, NW

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20004

ATTORNEY DOCKET NUMBER:	001082-7284
NAME OF SUBMITTER:	ROBERT J. GOODELL
Signature:	/Robert J. Goodell/
Date:	12/26/2013

Total Attachments: 2

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PATENT REEL: 031849 FRAME: 0554 40.00 2947773

ATTORNEY DOCKET NO.: - SOLE/JOINT INVENTION.. (U.S. Rights Only)..

ASSIGNMENT.

	WHEREA	AS I/We, the	e below named	inventor(s)	[hereinafter	referred to	as Assigno	r(s)], have
made an	invention	entitled:						

MOBILE PHONE

for which I WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. ____); and ...

WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, IWE HEREBY authorize and request the attorneys IWE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 29/477,735, filed Dec. 26, 2013) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s)... Date. Assignor's Signature Full Name of First Assignor. Dec. 13, 2013 Hyunseung SEO₽ Address <u>Seocho Raemian</u> 6 Cha 602-705, <u>Seocho-dong 1520-9, Seocho-gu</u>. Citizenship. Republic of Korea. Seoul, Korea. Date Assignor's Signature. Full Name of Second Assignor 1482 Dec. 13, 2013 Youngho KIM⊖ Citizenship... Address 302, Sinsa-dong 545-8, Gangnam-gu, Seoul, Korea. Republic of Korea. □ No a Names of additional inventors attached 🗵 Yes

> PATENT REEL: 031849 FRAME: 0555

Full Name of Third Assignor. Jihoon SHIN©	Assignor's Signature.	Date Dec 13, 2013
Address Hania Apt. 105-103, Umyeon-d	ong 67. <u>Seocho-gu</u> , Seoul, Korea	Citizenship. Republic of Korea ,
Names of additional inventors attached □Yes	⊠ No.,	

PATENT REEL: 031849 FRAME: 0556

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RECORDED: 12/26/2013